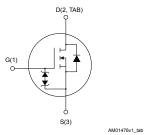
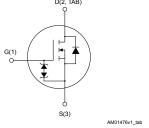


Datasheet

N-channel 600 V, 60 m Ω typ., 46 A MDmesh DM6 Power MOSFETs in a TO-247 and TO-247 long leads packages









Product status links			
STW65N60DM6			
STWA65N60DM6			

Product summary				
Order code	STW65N60DM6			
Marking 65N60DM6				
Package	TO-247			
Packing	Tube			
Order code	STWA65N60DM6			
Marking	65N60DM6			
Package	TO-247 long leads			
Packing	Tube			

Features

Order code	V _{DS}	R _{DS(on)} max.	I _D
STW65N60DM6	600 V	71 mΩ	46 A
STWA65N60DM6	000 V	7 1 11152	40 A

- Fast-recovery body diode
- Lower R_{DS(on)} per area vs previous generation
- Low gate charge, input capacitance and resistance
- 100% avalanche tested
- Extremely high dv/dt ruggedness
- Zener-protected

Applications

Switching applications

Description

These high-voltage N-channel Power MOSFETs are part of the MDmesh DM6 fast-recovery diode series. Compared with the previous MDmesh fast generation, DM6 combines very low recovery charge (Q_{rr}) , recovery time (t_{rr}) and excellent improvement in R_{DS(on)} per area with one of the most effective switching behaviors available in the market for the most demanding high-efficiency bridge topologies and ZVS phase-shift converters.



1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{GS}	Gate-source voltage	±25	V
1-	Drain current (continuous) at T _C = 25 °C	46	_
Ι _D	Drain current (continuous) at T _C = 100 °C	29	_ A
I _{DM} ⁽¹⁾	Drain current (pulsed)	140	Α
P _{TOT}	Total power dissipation at T _C = 25 °C	368	W
dv/dt ⁽²⁾	Peak diode recovery voltage slope	100	V/ns
di/dt ⁽²⁾	Peak diode recovery current slope	1000	A/µs
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	100	V/ns
T _{stg}	Storage temperature range	-55 to 150	°C
TJ	Operating junction temperature range	-55 (0 150	°C

- 1. Pulse width limited by safe operating area.
- 2. $I_{SD} \le 46~A,~V_{DS}~(peak) < V_{(BR)DSS},~V_{DD} = 400~V.$
- V_{DS} ≤ 480 V.

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R _{thJC}	Thermal resistance, junction-to-case	0.34	°C/W
R _{thJA}	Thermal resistance, junction-to-ambient	50	°C/W

Table 3. Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by T _J max)	6	Α
E _{AS}	Single pulse avalanche energy (starting $T_J = 25$ °C, $I_D = I_{AR}$; $V_{DD} = 50$ V)	900	mJ

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2 Electrical characteristics

 T_C = 25 °C unless otherwise specified

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	600			V
I	Zana mata walta na duala awanat	V _{GS} = 0 V, V _{DS} = 600 V			1	
I _{DSS}	Zero gate voltage drain current	V _{GS} = 0 V, V _{DS} = 600 V, T _C = 125 °C ⁽¹⁾			100	μA
I _{GSS}	Gate-body leakage current	V _{DS} = 0 V, V _{GS} = ±25 V			±5	μA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$	3.25	4.00	4.75	V
R _{DS(on)}	Static drain-source on resistance	V _{GS} = 10 V, I _D = 23 A		60	71	mΩ

^{1.} Defined by design, not subject to production test.

Table 5. Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	2500	-	pF
C _{oss}	Output capacitance	V _{DS} = 100 V, f = 1 MHz, V _{GS} = 0 V	-	125	-	pF
C _{rss}	Reverse transfer capacitance			4	-	pF
Coss eq. (1)	Equivalent output capacitance	V _{DS} = 0 to 480 V, V _{GS} = 0 V		204	-	pF
R _G	Intrinsic gate resistance	f = 1 MHz, I _D = 0 A	-	1.7	-	Ω
Qg	Total gate charge	V _{DD} = 480 V, I _D = 42 A, V _{GS} = 0 to 10 V		65.2	-	nC
Q _{gs}	Gate-source charge	(see Figure 14. Test circuit for gate	-	16.8	-	nC
Q _{gd}	Gate-drain charge	charge behavior)		30.2	-	nC

^{1.} $C_{\text{oss eq}}$ is defined as a constant equivalent capacitance giving the same charging time as Coss when V_{DS} increases from 0 to 80% V_{DSS} .

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V _{DD} = 300 V, I _D = 19 A,	-	21	-	ns
t _r	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$	-	22	_	ns
t _{d(off)}	Turn-off delay time	(see Figure 13. Test circuit for resistive load switching times and	-	56	-	ns
t _f	Fall time	Figure 18. Switching time waveform)	-	9	_	ns

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Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		46	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		140	Α
V _{SD} (2)	Forward on voltage	V _{GS} = 0 V, I _{SD} = 46 A	-		1.6	V
t _{rr}	Reverse recovery time	I _{SD} = 38 A, di/dt = 100 A/μs,	-	116		ns
Q _{rr}	Reverse recovery charge	V _{DD} = 60 V	-	0.58		μC
I _{RRM}	Reverse recovery current	(see Figure 15. Test circuit for inductive load switching and diode recovery times)	-	10		Α
t _{rr}	Reverse recovery time	I _{SD} = 38 A, di/dt = 100 A/μs,	-	208		ns
Q _{rr}	Reverse recovery charge	V _{DD} = 60 V, T _J = 150 °C	-	1.98		μC
I _{RRM}	Reverse recovery current	(see Figure 15. Test circuit for inductive load switching and diode recovery times)	-	19		Α

^{1.} Pulse width is limited by safe operating area.

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^{2.} Pulsed: pulse duration = 300 μ s, duty cycle 1.5%.



2.1 Electrical characteristics curves

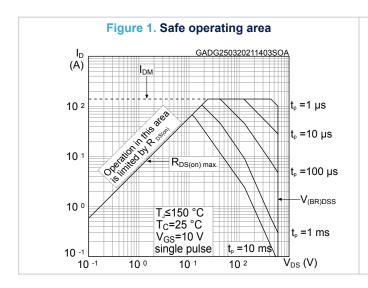
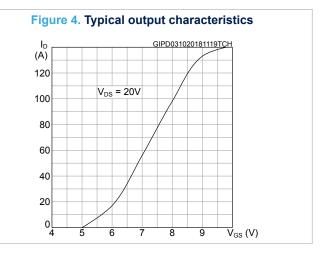
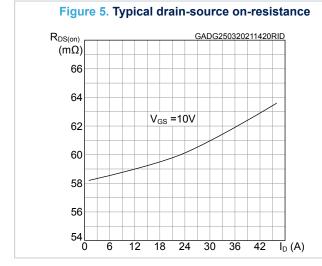
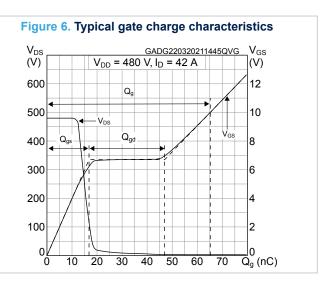


Figure 2. Maximum transient thermal impedance Z_{thJC} (°C/W) GADG250320211419ZTH 0.4 0.3 duty=0.5 10 -1 0.2 0.1 0.05 10 -2 Single pulse 10 -3 10 -5 10 -4 10 -3 10 -1 $\overline{t_p}$ (s) 10 -6 10 -2







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Figure 7. Typical capacitance characteristics

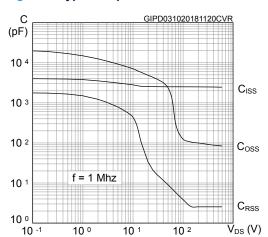


Figure 8. Normalized gate threshold vs temperature

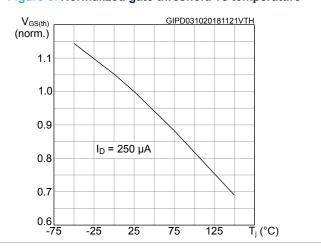


Figure 9. Normalized on resistance vs temperature

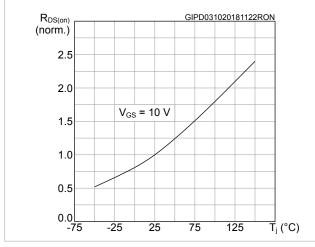


Figure 10. Typical output capacitance stored energy

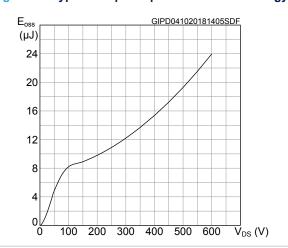


Figure 11. Normalized breakdown voltage vs temperature

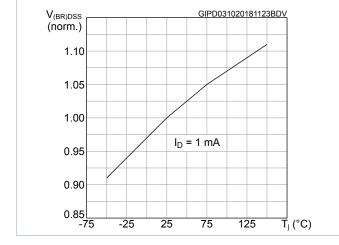
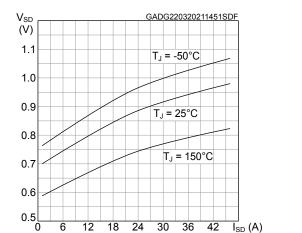


Figure 12. Typical reverse diode forward characteristics



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3 Test circuits

Figure 13. Test circuit for resistive load switching times

Figure 14. Test circuit for gate charge behavior

V_{GS}

Pulse width

2200

PF

47 kΩ

AND1469r10

Figure 15. Test circuit for inductive load switching and diode recovery times

AM01468v1

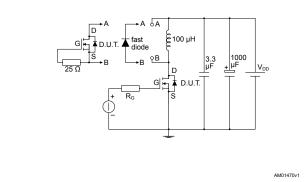


Figure 16. Unclamped inductive load test circuit

Figure 17. Unclamped inductive waveform

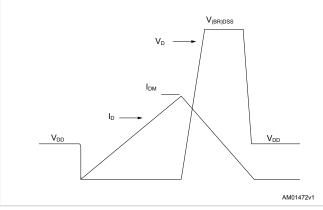
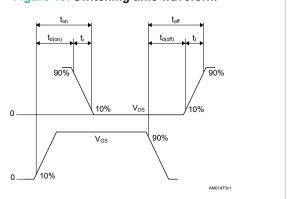


Figure 18. Switching time waveform



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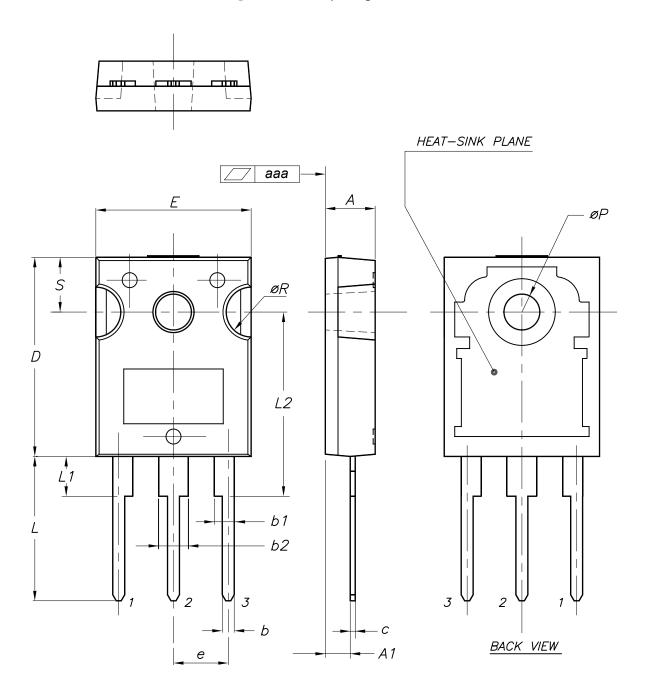


4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

4.1 TO-247 package information

Figure 19. TO-247 package outline



0075325_10

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Table 8. TO-247 package mechanical data

Dim.		mm	
Dim.	Min.	Тур.	Max.
А	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
Е	15.45		15.75
е	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70
aaa		0.04	0.10

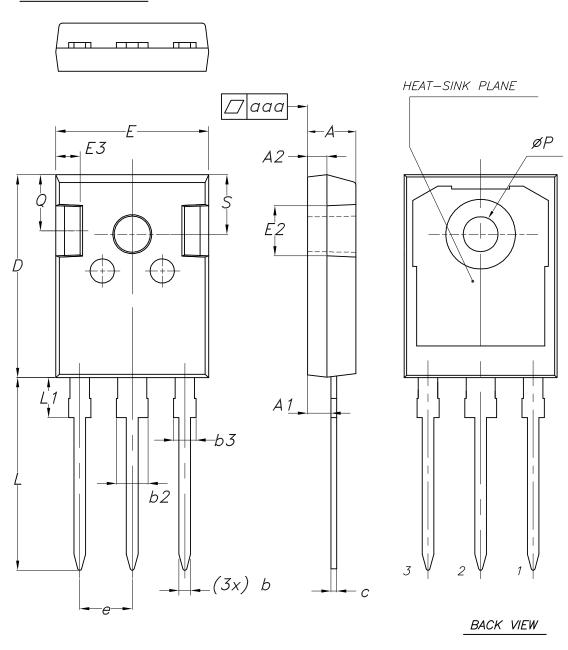
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4.2 TO-247 long leads package information

Figure 20. TO-247 long leads package outline

DIMENSIONS IN mm



8463846_3

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Table 9. TO-247 long leads package mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
A	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
b	1.16		1.26
b2			3.25
b3			2.25
С	0.59		0.66
D	20.90	21.00	21.10
E	15.70	15.80	15.90
E2	4.90	5.00	5.10
E3	2.40	2.50	2.60
е	5.34	5.44	5.54
L	19.80	19.92	20.10
L1			4.30
Р	3.50	3.60	3.70
Q	5.60		6.00
S	6.05	6.15	6.25
aaa		0.04	0.10

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Revision history

Table 10. Document revision history

Date	Version	Changes
02-Nov-2017	1	Initial release.
03-Oct-2018	2	Removed maturity status indication from cover page. The document status is production data. Updated title and features in cover page.
		Updated Updated Section 1 Electrical ratings, Section 2 Electrical characteristics. Added Section 2.1 Electrical characteristics curves. Minor text changes.
17-Jun-2020	3	Updated Table 1. Absolute maximum ratings.
31-Mar-2021	4	Updated Table 1. Absolute maximum ratings, Table 2. Thermal data, Table 4. On/off states, Table 7. Source drain diode, Figure 1. Safe operating area, Figure 2. Maximum transient thermal impedance and Figure 6. Gate charge vs gate-source voltage.
21-May-2021	5	Updated Section 4.2 TO-247 long leads package information. Minor text changes.

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